

AN 82:128418 HCA  
TI Copper-thallium alloys with good heat resistance and electrical conductivity  
IN Sakamoto, Mutsuo; Sotomura, Takashi  
PA Furukawa Electric Co., Ltd.  
SO Japan., 3 pp.  
CODEN: JAXXAD  
DT Patent  
LA Japanese

FAN.CNT 1

	PATENT NO.	KIND	DATE	APPLICATION NO.	DATE
PI	JP 49007777	B4	19740222	JP 1970-87320	19701005
AB	The Cu alloy contains Tl 0.005-0.08 and O >0.0005%. The alloy is cooled from 900-1050.degree. at >5 .degree.C/min, hot worked at >750.degree., cold worked, and annealed at >600.degree..				